# CRAY Y-MP EL™ and CRAY EL98™ Illustrated Parts Catalog

CQQ-0709-000

Cray Research Proprietary

Cray Research, Inc.

# **Record of Revision**

Each time this manual is updated with a change packet, a change to part of a text page is indicated by a change bar in the margin directly opposite the change. A change bar in the footer of a text page indicates that most, if not all, of the text is new. A change bar in the footer of a page composed primarily of a table and/or figure may indicate that a change was made to that table/figure or, it could indicate that the entire table/figure is new. Change packets are assigned a numerical designator, which is indicated in the publication number on each page of the change packet.

Each time this manual is fully revised and reprinted, all change packets to the previous version are incorporated into the new version, and the new version is assigned an alphabetical revision level, which is indicated in the publication number on each page of the manual. A revised manual does not usually contain change bars.

#### **REVISION**

#### **DESCRIPTION**

September 1993. Original Printing.

## **PREFACE**

The CRAY Y-MP EL and the CRAY EL98 computer systems may be serviced by either Cray Research, Inc. engineers, customer engineers, or third party maintainers. This illustrated parts catalog is provided to assist service personnel in identifying part numbers for parts they need to replace.

The parts described in this catalog are major components, or field-replaceable units, for the CRAY Y-MP EL and CRAY EL98 systems. The components and their removal and replacement procedures are included in the CRAY EL Series Troubleshooting and Maintenance Manual, Cray Research publication number CMM-0431-0B0.

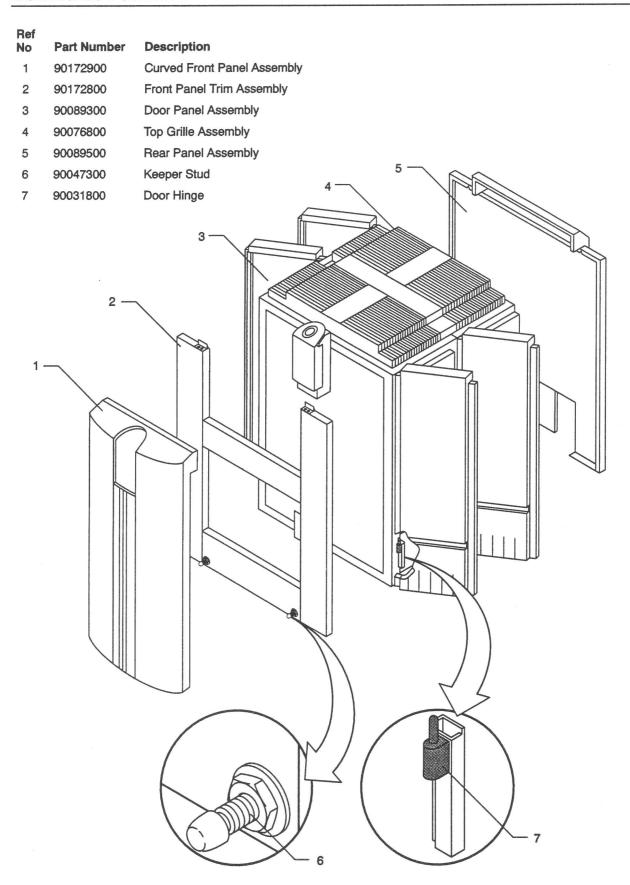
# CRAY Y-MP EL AND CRAY EL98 ILLUSTRATED PARTS CATALOG

The information in this catalog is arranged by functional areas of the machine. Because the hardware of the CRAY EL98 system is nearly identical to the CRAY Y-MP EL system, the two systems have been combined in this catalog; any CRAY EL98 differences have been noted throughout.

In some instances part names and numbers vary depending on the configuration of the system. In such cases, these variances have been noted.

Our parts ordering system is set up to ensure shipment of the most up-to-date parts. When you order parts using the part numbers in this catalog, you can be assured you will receive the latest revisions of the parts even if the part numbers have changed.

#### **Mainframe Panels**

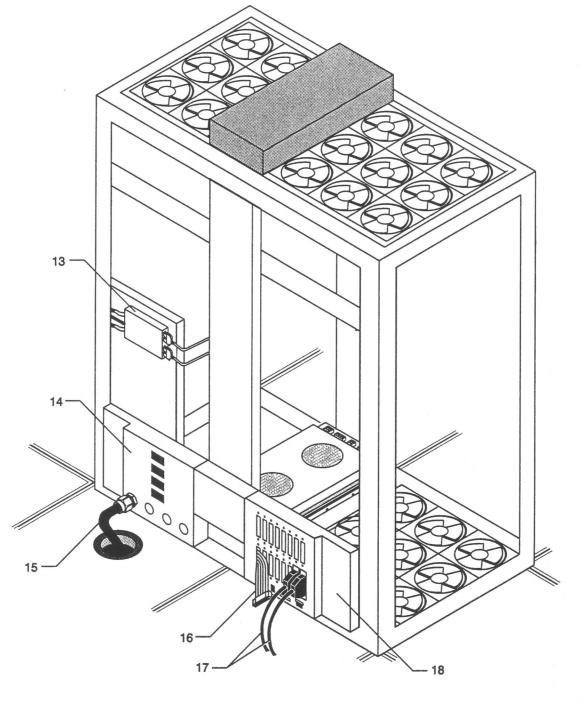


# Power (Front View)

Ref		
No	Part Number	Description
8	90013301	Exhaust (Top) Fan Tray Assembly
9	90046101	Bulk Converter Assembly
10	90013203	Control Panel
11	90013401	Intake (Lower) Fan Tray Assembly (This is not the assembly that fits under CPU card cage. Refer to page 14, reference number 62 for the CPU fan tray assembly.)
12	90027401	Capacitor Bank 8
	10	

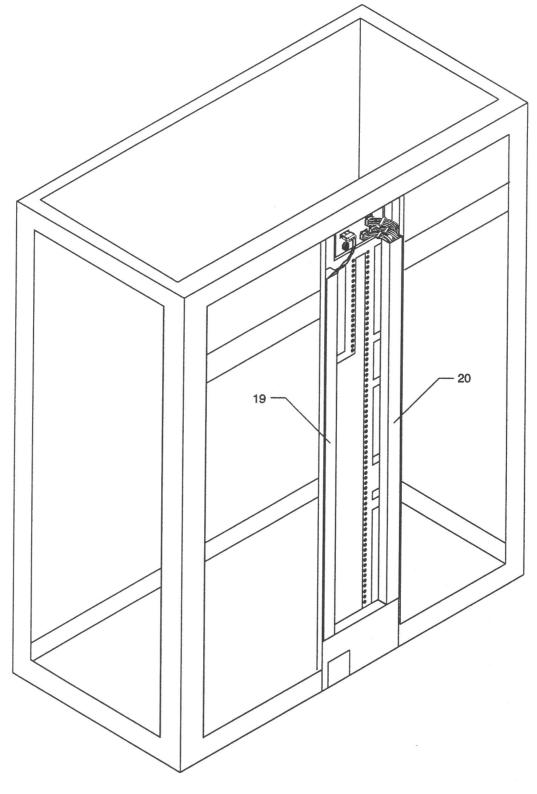
# Power (Back View)

Ref No	Part Number	Description	Ref No	Part Number	Description
13	90156600	FDDI Switch Module Assembly	16	90156800	External SCSI Cable
14	90022500	Incoming Power Module Assembly	17	90216400	External HIPPI Cables (Set of 2)
15	90086601	Domestic Power Cord	18	90053600	Connector Bulkhead Assembly
	90097401	International Power Cord			



# Power (Vertical Wireway)

Ref No	Part Number	Description
19	90157300	Inhibit Distribution Kit
20	90053800	Power Distribution Kit



# **IOS VME Card Cage**

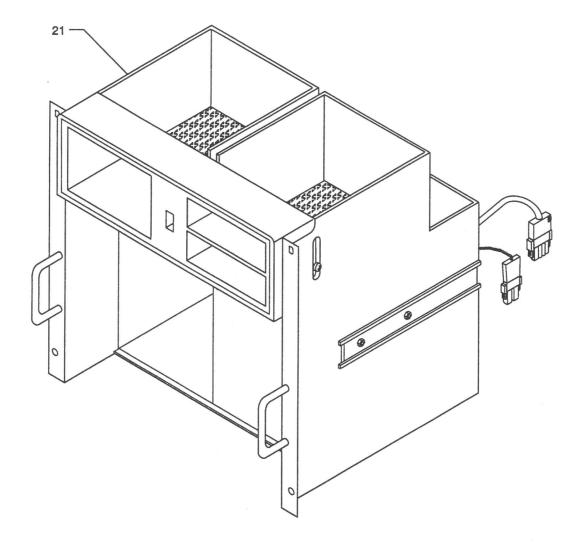
Ref

No Part Number Description

21 90140300 IOS VME Chassis Assembly

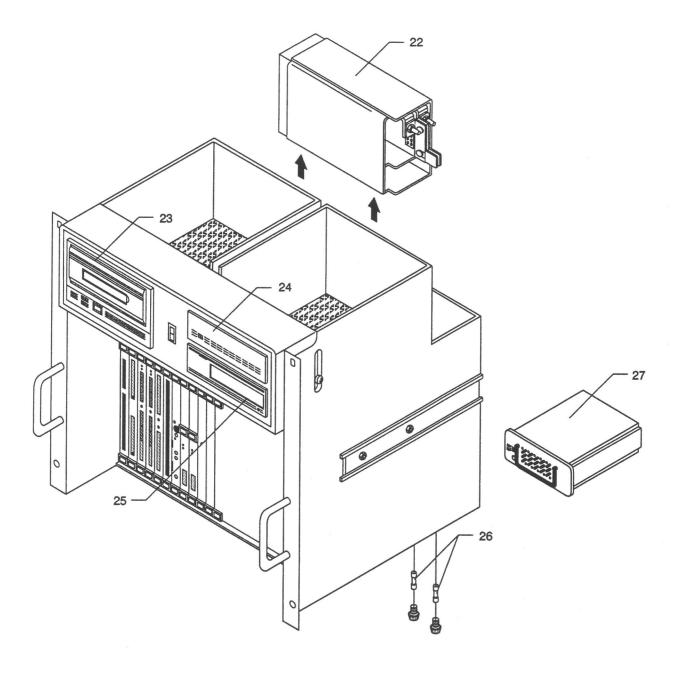
NOTE: When you order the part number above, you receive everything shown in this diagram.

This part number does not include the power supply.

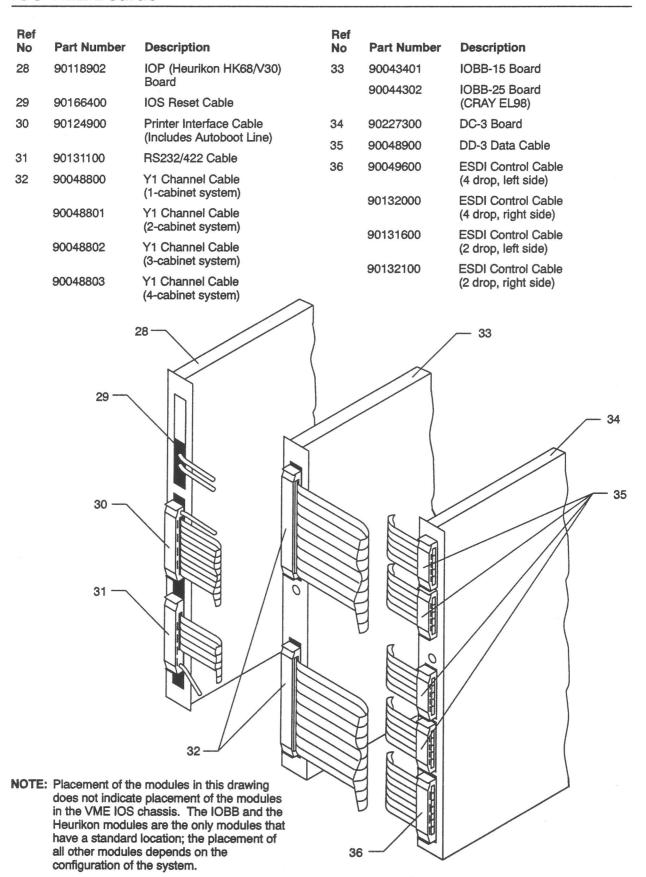


# **IOS VME Card Cage Assembly**

Ref No	Part Number	Description	Ref No	Part Number	Description
22	90035900	VME Power Supply	26	90067407	Fuses
23	90215200	EX-2 Tape Unit Assembly	27	90184200	DR-2 Removable Drive
24	90237100	HD-1 Tape Unit Assembly (Hard Disk Drive)			(This drive is exchangeable with the HD-1.)
25	90168604	QIC Tape Drive Assembly (DS-2 Tape Unit Assembly) (Streaming Tape Drive)			

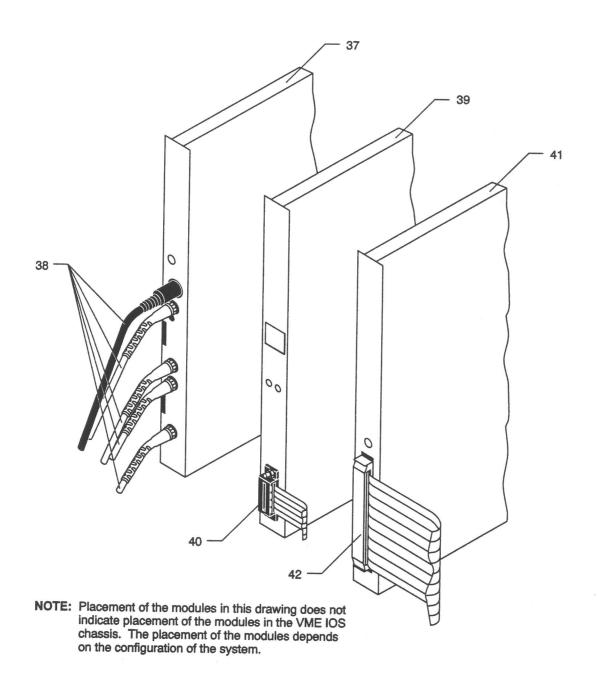


#### **IOS VME Boards**



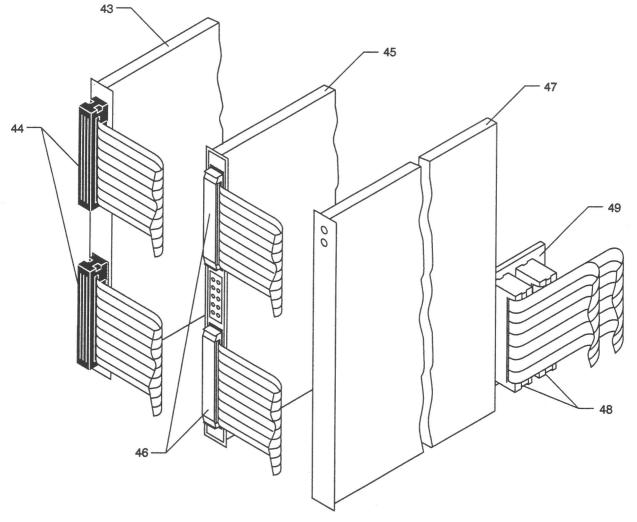
# **IOS VME Boards (continued)**

Ref No	Part Number	Description	Ref No	Part Number	Description
37	90227400	FI-1 Board	42	90123000	TD-3 Logic Cable
38	These cables c	an be ordered only by			(if cable leads to TD-3)
	ordering the FD (refer to page 4	DDI module switch assembly , reference number 13).		90156800	SCSI Bulkhead Cable (if cable leads to Connector
39	90227200	EI-1 Board			Bulkhead Assembly)
40	90152600	Ethernet Cable		90162000	TD-3 Jumper Cable (if system has 2 TD-3s)
41	90089702	SI-1 Board			(ii dydidiii ilad 2 1D-08)



# **IOS VME Boards (continued)**

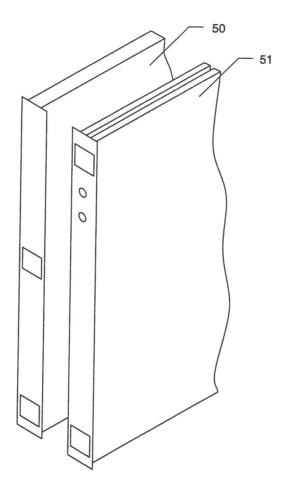
Ref No	Part Number	Description	Ref No	Part Number	Description
43	90233900	DC-4 Board	46	90244400	Hyperchannel Cable
44	90123300	PE-4 Logic (Control and	47	90237700	TC-2 Board
		Data) Cable	48	90135000	TC-2 Adapter Module
45	90237800	HC-1 Board (Hyperchannel Interface Card)	49	90122600	TD-2 Logic Cable



NOTE: Placement of the modules in this drawing does not indicate placement of the modules in the VME IOS chassis. The placement of the modules depends on the configuration of the system.

# **IOS VME Boards (continued)**

Ref No	Part Number	Description
50	90237600	BMR-C Module
51	90237500	BMR-M Module



NOTE: The placement of the two modules in this drawing is important. The BMR-C module must always be placed before, or to the left, of the BMR-M module.

# **CPU Card Cage**

Ref No Part Number Description

52 90012701 CPU Card Cage Assembly

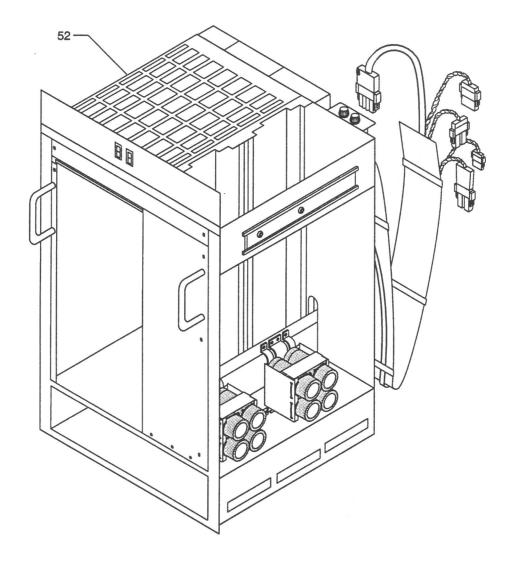
(CRAY Y-MP EL)

90200200 CPU Card Cage Assembly

(CRAY EL98)

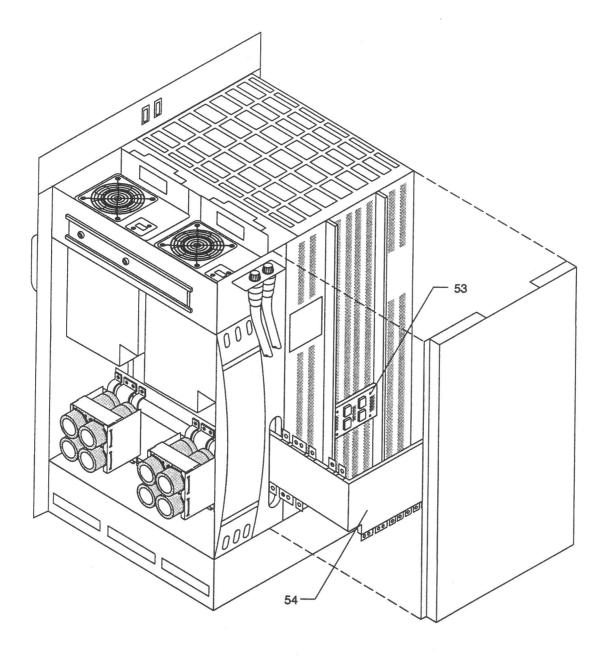
NOTE: When you order the part number above, you

receive everything shown in this diagram.

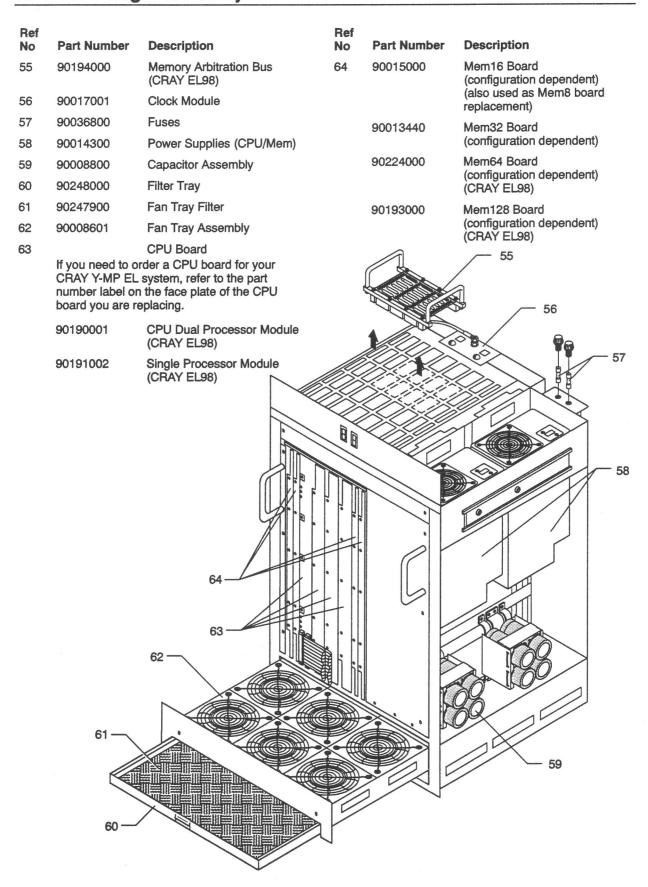


# CPU Card Cage Assembly (Back View)

Ref No	Part Number	Description
53	90063000	Scan Adapter Board
54	90008200	Bus Bar Assembly



#### **CPU Card Cage Assembly**

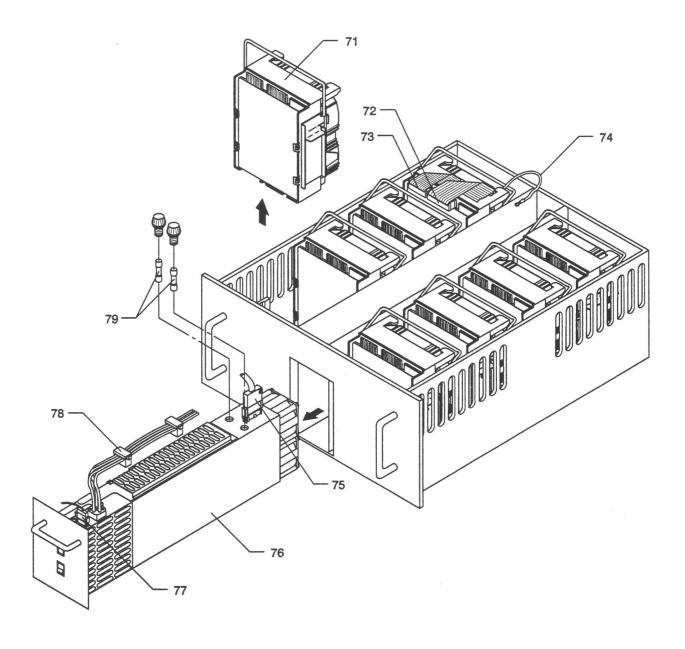


# CPU Board with Y1 Channel Board and HIPPI Boards

Ref No	Part Number	Description	Ref		
65	90045500	Description	No	Part Number	Description
66	90227600	Source HIPPI Board Internal Source Cable	70	90018001	Y1 Channel Board (with CC02 ASIC)
67	90019001	Destination HIPPI Board		90018002	Y1 Channel Board
68	90227601	Internal Destination Cable			(with CC05 ASIC)
69	90048800	Y1 Channel Cable (1-cabinet system)			
	90048801	Y1 Channel Cable (2-cabinet system)			
	90048802	Y1 Channel Cable (3-cabinet system)			
	90048803	Y1 Channel Cable (4-cabinet system)			
		68			

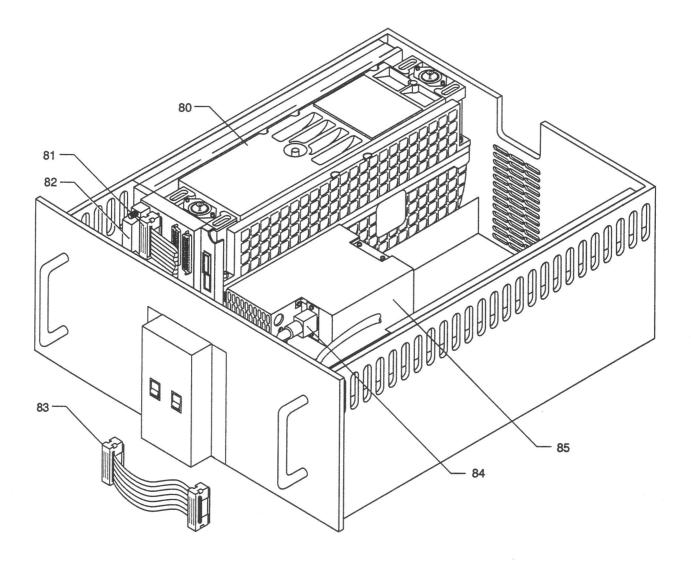
# PE-3 Tray Assembly

Ref No	Part Number	Description	Ref No	Part Number	Description
71	90250400	DD-3 Drive Assembly	73	90048900	Data Cable
72 90049600	90049600	ESDI Control Cable	74	90209000	Ground Cable
		(4 drop, left side)	75	90110800	HVdc Input Cable
	90132000	ESDI Control Cable (4 drop, right side)	76	90139200	Power Supply Assembly
90131600	90131600	ESDI Control Cable	77	90091700	Inhibit Control Cable
		(2 drop, left side)	78	90142700	Daisy Chain Power Cable
	90132100	ESDI Control Cable (2 drop, right side)	79	90067404	Fuses



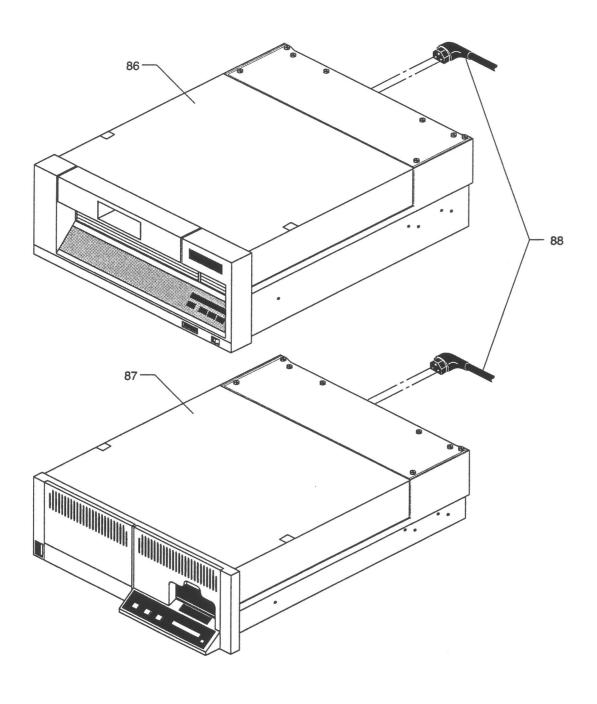
# PE-4 Drawer Assembly

Ref No	Part Number	Description
80	90073200	IPI Drive
81	90123300	Logic Cable
82	90118100	Terminator
83	90136700	Logic Jumper Cable (Used when there are 2 IPI drives.)
84	90051900	Power Cable
85	01488200	Power Supply



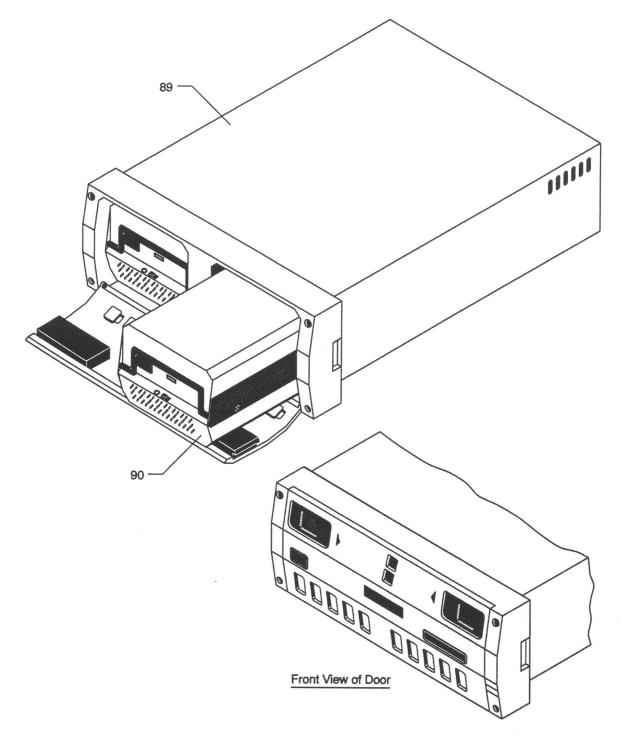
# TD-2 and TD-3 Tape Drives

Ref No	Part Number	Description
86	90250600	TD-2 9-track Tape Drive
87	90250700	TD-3 18-track Tape Drive
88	90159200	Power Input Cable



# **Datashuttle and DR-1**

Ref No	Part Number	Description
89	90158800	Datashuttle Kit (Datashuttle and DR-1 Cannisters)
90	90074600	DR-1 Cannister only



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